

0505 0805
1005 1206

N-

Series

2010 2512
2525 3725



Features

Very high power dissipation

Thick film technology

AlN substrate material

Resistance values from 10 ohms to 2 Kohms†

Standard tolerance 5%

Tight TCRs

Thick Film High Power Chip Resistors and Terminations on Aluminum Nitride

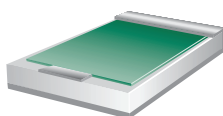
The **ims** N-Series thick film high power chip resistors and chip terminations on aluminum nitride are ideal for most applications requiring high thermal conductivity in a small size package. AlN is an ideal replacement for BeO with its high power dissipation and no environmental or health hazards. Thick film technology provides a stable resistive element at a very affordable price. These chips feature the following:

- High stability thick film resistive element
- AlN substrate material
- Standard resistance range is 10Ω to 2KΩ†, other values available*
- Standard tolerance is 2% or 5%, other tolerances available*
- Operating temperature: -55°C to +155°C
- Maximum working voltage: $E = \sqrt{PR}$
- Available in bulk or tape and reel*

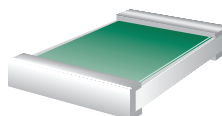
*Consult factory

Please see ordering information on the back.

Terminal styles



SG - Single wrap with groundplane



WA- Full wraparound

Various additional styles are available. Please see reverse.

Rated Power

Terminal materials:

- 3 ✓ PtAg (platinum silver) for epoxy or solder attachment
- 8 ✓ ULR PtAg (platinum silver) for epoxy or solder attachment
- 7 ✓ Gold over PtAu (platinum gold) for bonding
- C Sn62 Solder coated PtAg for solder attachment
- H ULR Sn62 Solder coated PtAg for solder attachment
- P ✓ Sn96 Solder coated PtAg for solder attachment
- R ✓ ULR Sn96 Solder coated PtAg for solder attachment

Thickness		0.015" "D"			0.025" "G"			0.040" "T"		
Baseplate Temp		50°C	70°C	100°C	50°C	70°C	100°C	50°C	70°C	100°C
CASE SIZE	0505	30W	25W	16W	20W	16W	10W	N/A	N/A	N/A
	0805	50W	37W	25W	30W	25W	16W	N/A	N/A	N/A
	1005	60W	48W	30W	40W	30W	20W	N/A	N/A	N/A
	1206	105W	85W	55W	70W	55W	35W	N/A	N/A	N/A
	2010	150W	120W	75W	90W	75W	48W	60W	48W	30W
	2512	200W	150W	100W	120W	100W	60W	70W	60W	38W
	2525	N/A	N/A	N/A	240W	190W	120W	150W	120W	75W
	3725	N/A	N/A	N/A	380W	310W	200W	250W	200W	125W

A Word About Thermal Management

Tests of aluminum nitride "SG" 50Ω terminations demonstrate the above power capacities, assuming a thermally conductive application where the steady-state baseplate temperature of the chip is maintained at or below the values identified in the above table and the maximum film temperature did not exceed 150°C. The data also shows that the ratio of temperature rise versus power applied increases with increasing chip size (for a given thickness) so the above criteria should be carefully considered when operating larger chips. As with any application, actual performance of these chips will depend on a host of circuit dependent parameters.

† Max value for 0505 and 2525 sizes is 1KΩ

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Dimensions

Case	Length	Width	Height Option 'D'	Height Option 'G'	Height Option 'T'	Choose the height option that best suits your power dissipation needs (see Rated Power chart on reverse) and build your Part Number below.
0505	0.050"	0.050"	0.020"Max	0.035"Max	N/A	
0805	0.080"	0.050"	0.020"Max	0.035"Max	N/A	
1005	0.100"	0.050"	0.020"Max	0.035"Max	N/A	
1206	0.126"	0.063"	0.020"Max	0.035"Max	N/A	
2010	0.197"	0.098"	0.020"Max	0.035"Max	0.050"Max	
2512	0.250"	0.120"	0.020"Max	0.035"Max	0.050"Max	
2525	0.250"	0.250"	N/A	0.035"Max	0.050"Max	
3725	0.375"	0.250"	N/A	0.035"Max	0.050"Max	

Additional options available. Please contact factory.

For detailed dimensional information, outline drawing is available from factory.

Termination Style Availability

	WA	SS	SB	SG	CS	EW	DE	ZG
0505	•	•	•	•	N/A	N/A	N/A	N/A
0805	•	•	•	•	•	•	N/A	N/A
1005	•	•	•	•	•	•	•	N/A
1206	•	•	•	•	•	•	•	N/A
2010	•	•	•	•	•	•	•	•
2512	•	•	•	•	•	•	•	•
2525	•	•	•	•	•	•	•	•
3725	•	•	•	•	•	•	•	•

• Indicates Availability

Ordering Information

Example: 33Ω, 2%, 2010 Center Strip style resistor on 0.015" substrate with PtAg terminations

Example: N D 3 - 2010 CS 33R0 G			
Substrate Thickness D - 0.015" ¹ G - 0.025" T - 0.040" ²		Tolerance G - 2% J - 5%	
Termination Material ✓ 3 - PtAg ✓ 8 - ULR PtAg ✓ 7 - Au over PtAu ³ C - PtAg w/ Sn62 Solder H - ULR PtAg w/ Sn62 Solder ✓ P - PtAg w/ Sn96 Solder ✓ R - ULR PtAg w/ Sn96 Solder		Resistance value† The first three digits are significant values. The fourth is the number of zeroes following. The R indicates a decimal point for resistance values less than 100Ω.	
Case Size 0505 2010 0805 2512 1005 2525 1206 3725		Style WA SB CS DE SS EW ZG ⁴ SG ⁵	

1. 0.015" Substrate available in sizes 2512 and smaller

2. 0.040" Substrate available in sizes 2010 and larger

3. Au over PtAu terminal metalization available on Single Sided, Single Sided with Backplane and Single Wrap to Ground only. A NX7- Single Wrap to Ground style features bondable terminal on input pad only, ground pad in PtAu.

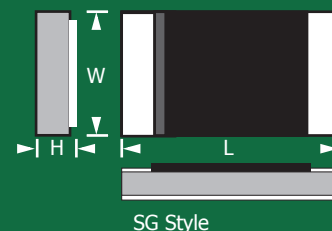
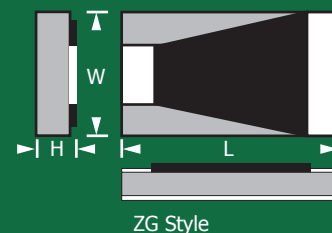
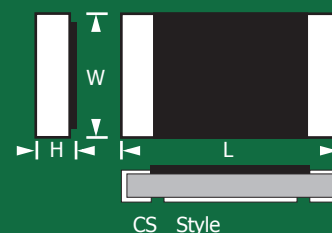
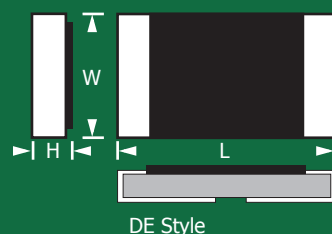
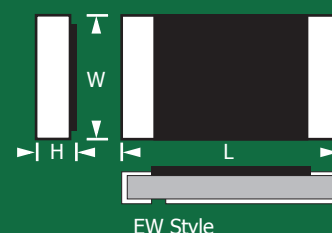
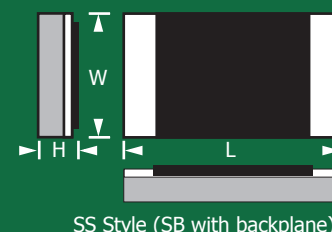
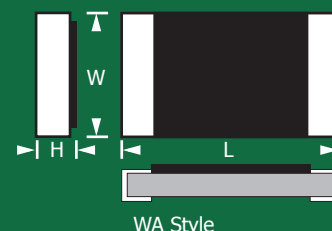
4. 'ZG' denotes a Single Wrap to Ground terminal style with a trapezoidal resistor body available in sizes 2010 and larger

5. 'SG' denotes a Single Wrap to Ground terminal style with a rectangular resistor body

† Max value for 0505 and 2525 sizes is 1KΩ

✓ Indicates RoHS compliance

N-Series Ver 10 08/15 Specifications subject to change without notice



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